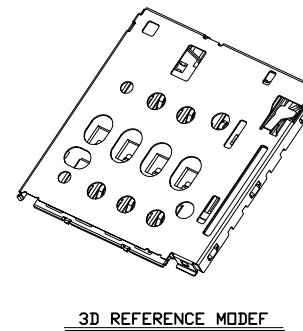
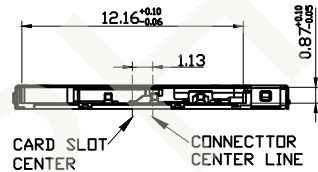
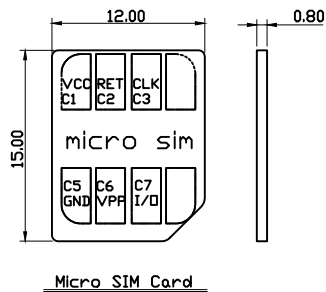
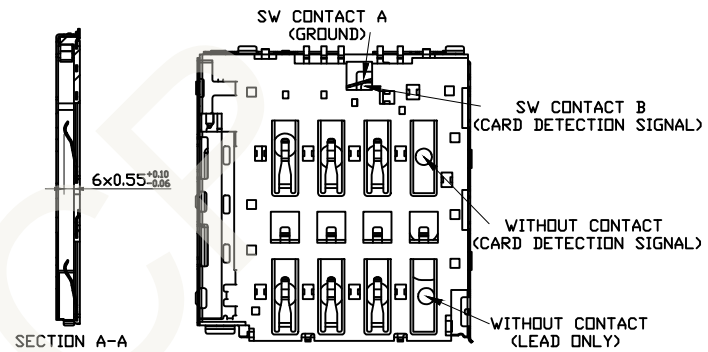
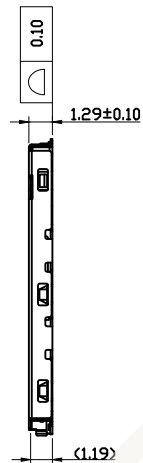
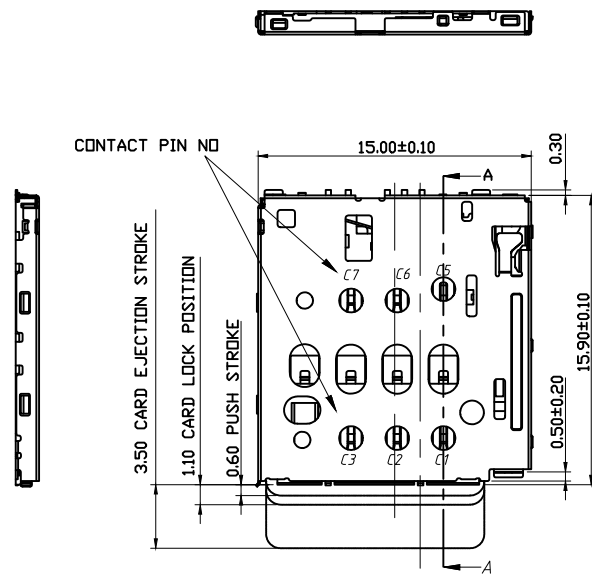


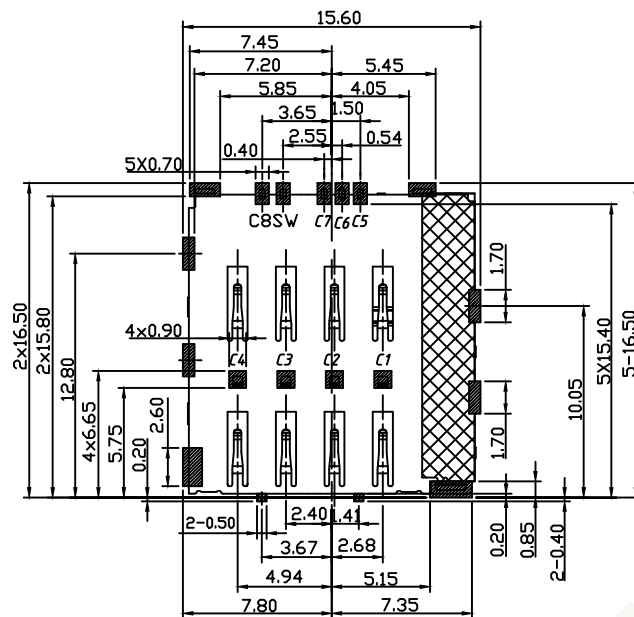


NINGBO RHT ELECTRONIC CO.,LTD

UNITS:mm	SHEET SIZE: A4	SCALE:---	DRWN BY PAN
0~3	3~18	18~50	50~120
±0.12	±0.15	±0.3	±0.5

CHK'D BY FENG
APPR BY ZHAN

Micro SIM CONN;PUSH/PUSH,8Pin, H1.29mm,with CD Pin	
THIRD ANGLE PROJECTION	RHTAYIM-093-H1.29-R



CIRCUIT TRACE KEEP AREA
 SMT SOLDER AREA

RECOMMENDED PCB LAYOUT
 COMPONENT SIDE(TOLERANCE±0.05)

Material:

Housing:High Temperature Thermoplastic,UL94V-0

Contact:Copper Alloy,Au 1u",Solder area:Gold Flash;Under plate Ni40u"

Min all over

Shell:SUS,Plated 30U" Ni Overall,Solder area:Gold Flash

Electrical:

Current Rating:0.5A

Voltage Rating:50V DC Max.

Contact Resistance:100mΩ Max.

Dielectric Withstanding Voltage:500V AC

Insulation Resistance:1000MΩ Min./250VDC

Ambient Temperature Range:-20°C +85°CStorage

Temperature Range:-40°C~+ 70°C Ambient Humidity Range:95%
R.H. Max.

Peak Temperature:260°C±5°C

Mating Cycles:5000 Insertions

SIM PIN Assignment

PIN NO	Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O

CARD INSERTION STATE	CARD DETECT SW
CARD UN-INSERTION	CLOSE ② SW CONTACT B(CARD DETECTION SIGNAL) ① SW CONTACT A(USE ONLE)
CARD INSERTION	OPEN ② SW CONTACT B(CARD DETECTION SIGNAL) ① SW CONTACT A(USE ONLE)

NINGBO RHT ELECTRONIC CO.,LTD

UNITS:mm	SHEET SIZE: A4		SCALE:---
0~3	3~18	18~50	50~120
±0.12	±0.15	±0.3	±0.5

DRWN BY PAN

CHK'D BY FENG

APPR BY ZHAN

Micro SIM CONN;PUSH/PUSH,8Pin,
H1.29mm,with CD Pin

THIRD ANGLE PROJECTION



RHTAYIM-093-H1.29-R